

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t1711cms8#trpbf

(Engineering Calculation)

MSOP

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TOTAL MASS (g) : 0.026075

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001100	1000000	42185.9570312		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.010433	975000	400114.625		
		Iron (Fe)	7439-89-6	0.000257	24000	9856.17480469		
		Phosphorus (P)	7723-14-0	0.000003	300	115.052619934		
		Zinc (Zn)	7440-66-6	0.000007	700	268.456115723		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.010700	1000000	410354.34375		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	27230.0761719		
		External Plating Total:				0.000710	1000000	27230.0761719
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	3298.17504883		
Internal Plating Total:				0.000086	1000000	3298.17504883		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000472	750000	18101.6113281		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000157	250000	6021.08691406		
Die Attach Total:				0.000629	1000000	24122.6992188		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001659	130000	63624.0976562		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.010591	830000	406174.09375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000447	35000	17142.8398438		
		Carbon Black (C)	1333-86-4	0.000064	5000	2454.45605469		
		Encapsulation Total:				0.012761	1000000	489395.46875
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000089	1000000	3413.22753906		
					TOTAL MASS (g) :	0.026075		